

WP287P2015MS

15W RF GaN Power Transistor



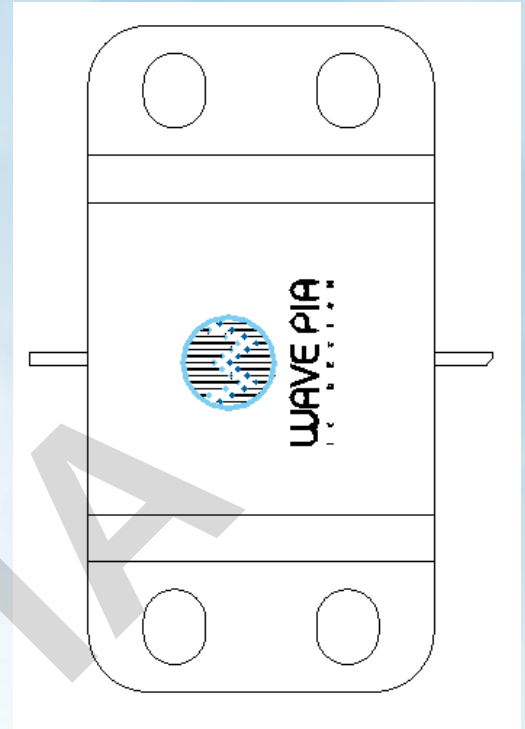
WAVE PIA
I C D E S I G N

Product Features

- 6.95 to 7.45 GHz Operation
- 13.17 dB Small Signal Gain at 7.2GHz
- 18.8 W Typical P_{sat} at 7.2GHz
- 57.8 % Drain Efficiency at 7.2GHz
- 28 V Operation

Applications

- Broadband Amplifiers
- Radio Link
- SATCOM
- Radar application



Absolute Maximum Ratings

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	V_{DSS}	160	Volts	25 °C
Gate-to-Source Voltage ³	V_{GS}	-10, +2	Volts	25 °C
Storage Temperature ³	T_{STG}	-65, +150	°C	
Operating Junction Temperature ^{1,3}	T_J	225	°C	
Maximum Forward Gate Current ³	I_{GMAX}	30	mA	25 °C
Maximum Drain Current ²	I_{DMAX}	1	A	$I_d@ V_d = 10V, V_g = 1V$
Soldering Temperature ³	T_S	245	°C	
Storage Temperature ³	T_{STG}	-65, +150	°C	

Note:

1. Continuous use at maximum temperature will affect MTTF.
2. Current limit for long term, reliable operation
3. After additional updates

DC Characteristics¹ (TC = 25 °C)

Parameter	Symbol	MIN	TYP	MAX	Units	Conditions
Gate Threshold Voltage	$V_{GS(th)}$		-3.0		V_{DC}	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$
Gate Quiescent Voltage	$V_{GS(Q)}$		-2.3		V_{DC}	$V_{DS} = 28\text{ V}, I_D = 150\text{ mA}$
Saturated Drain Current ²	I_{DS}		1000		mA/mm	$V_{DS} = 10\text{ V}, V_{GS} = 1\text{ V}$
Drain-Source Breakdown Voltage	V_{BR}	160			V_{DC}	$I_D = 1\text{ mA/mm}$

Note:

1. Measured on wafer prior to packaging.
2. Scaled from PCM data.

RF Characteristics (TC = 25 °C, F0 = 7.2GHz unless otherwise noted)

Parameter	Symbol	MIN	TYP	MAX	Units	Conditions
Power Gain	G_{Sat}		9		dB	$V_{DD} = 28\text{ V}, I_{DQ} = 150\text{ mA}, \text{Pulse Width} = 100\text{ usec}, \text{Duty Cycle} = 10\%$
Saturated Output Power	P_{SAT}		18.8		W	$V_{DD} = 28\text{ V}, I_{DQ} = 150\text{ mA}, \text{Pulse Width} = 100\text{ usec}, \text{Duty Cycle} = 10\%$
Drain Efficiency ¹	η		57.8		%	$V_{DD} = 28\text{ V}, I_{DQ} = 300\text{ mA}, \text{CW}$

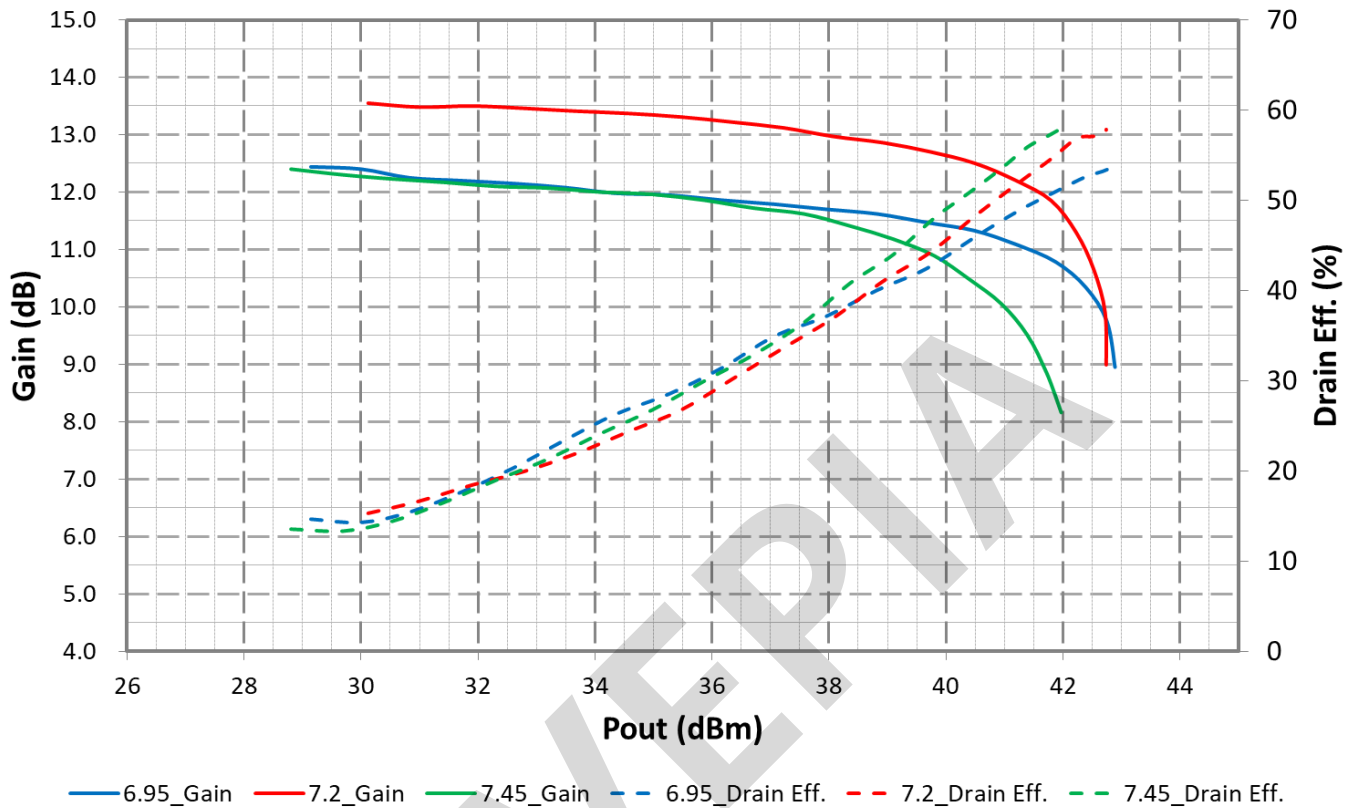
Note:

1. Drain Efficiency = P_{OUT}/P_{DC}

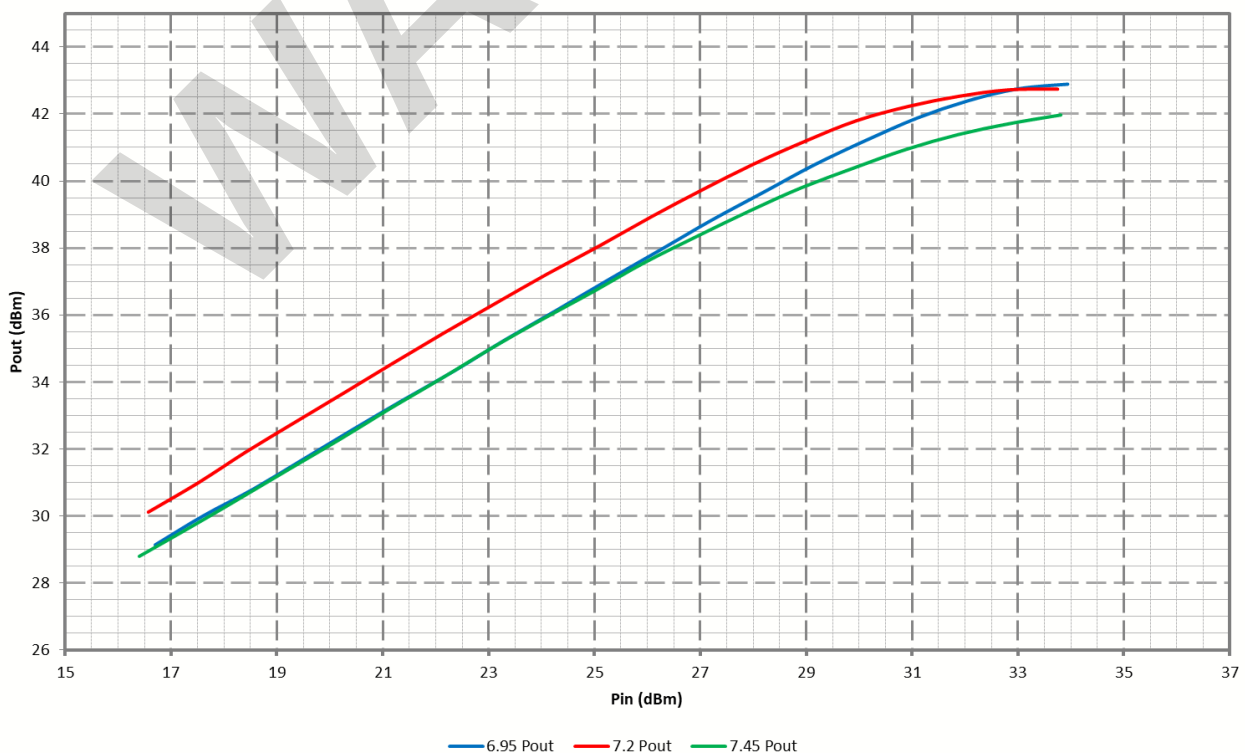
Pulse Signal Performance (Tc=25°C, Measured in the test board amplifier circuit)

VDD = 28 V, IDQ = 150 mA, PulseWidth = 100μsec, Duty Cycle = 10%

Gain, Drain Eff. vs. Pout

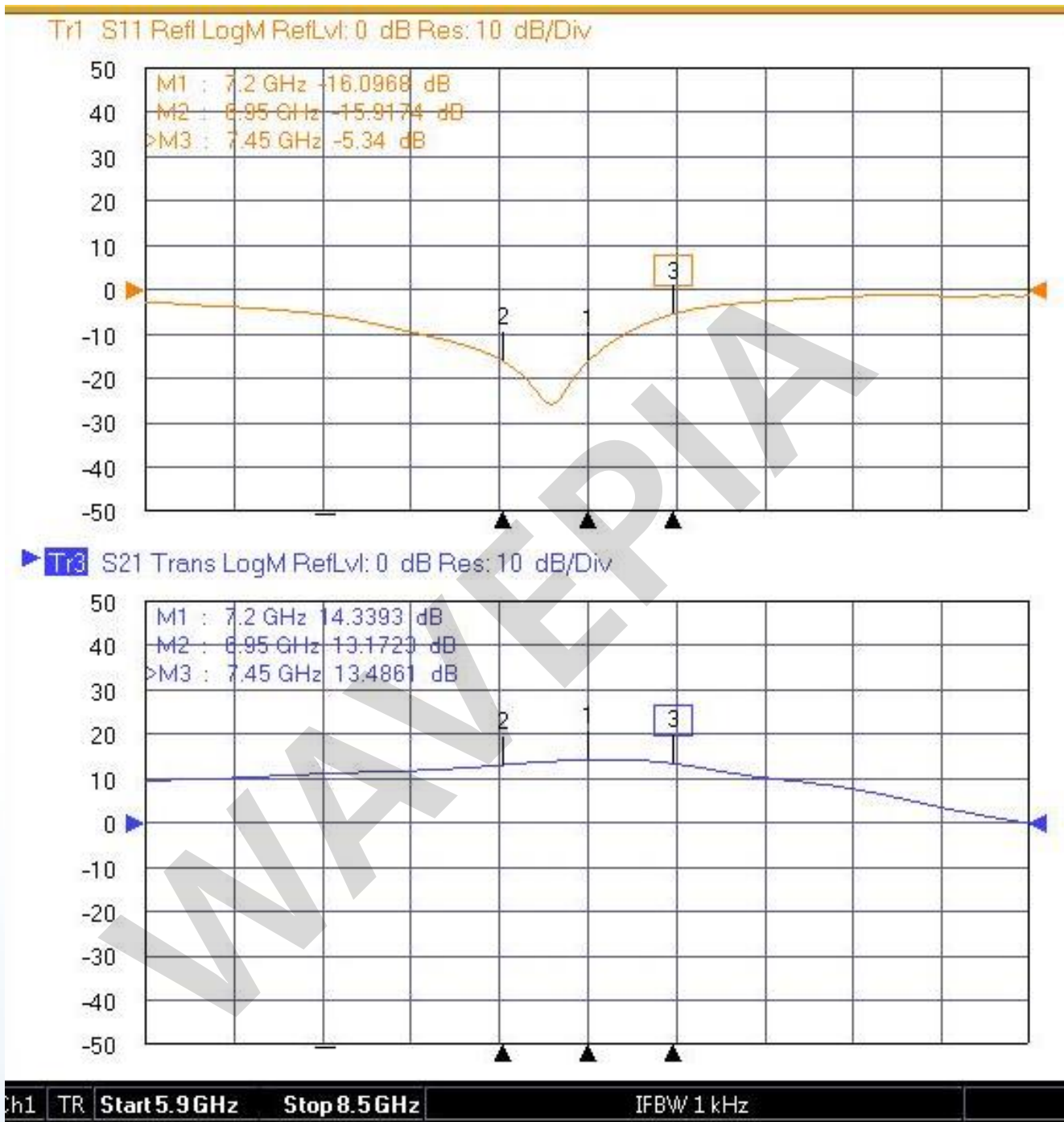


Pout vs. Pin

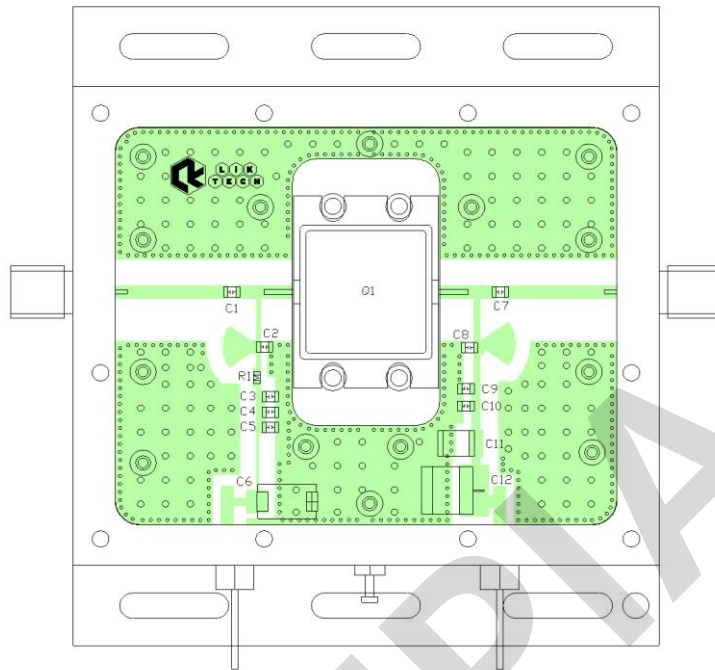


Small Signal Performance (Tc=25°C, Measured in the test board amplifier circuit)

VDD = 28 V, IDQ = 150 mA



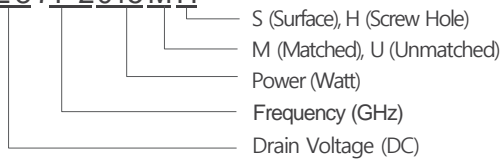
Demonstrationboard



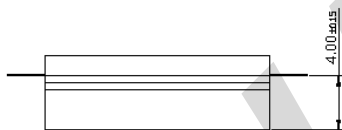
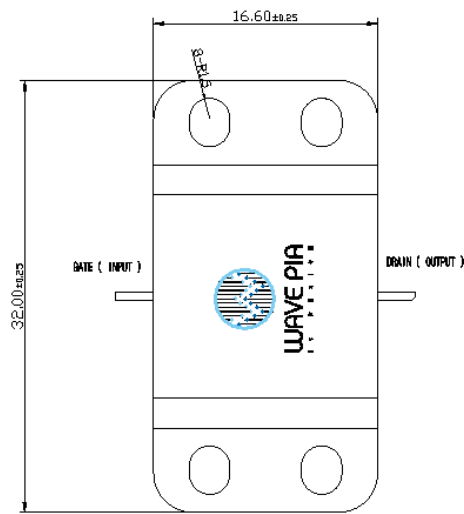
Reference	Value	Description	Package	Manufacturer
C1,C7	2.0pF	High Q Capacitor	2012	Johanson
C2,C8	10pF	High Q Capacitor	2012	Johanson
C3	100pF	Ceramic Capacitor	2012	SAMSUNG
C4	10nF	Ceramic Capacitor	2012	SAMSUNG
C5	1uF	Ceramic Capacitor	2012	SAMSUNG
C6	47uF	Tantalum Capacitor	7343	Vishay
C9	100pF	High Q Capacitor	2012	Johanson
C10	220pF	High Q Capacitor	2012	Johanson
C11	470nF	High V Capacitor	4532	Johanson
C12	47uF	Tantalum Capacitor	7360	Vishay
R1	10Ω	Chip Resistor	1608	SAMSUNG

Part number code

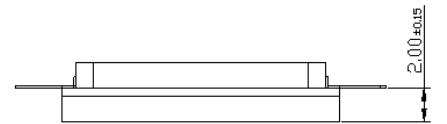
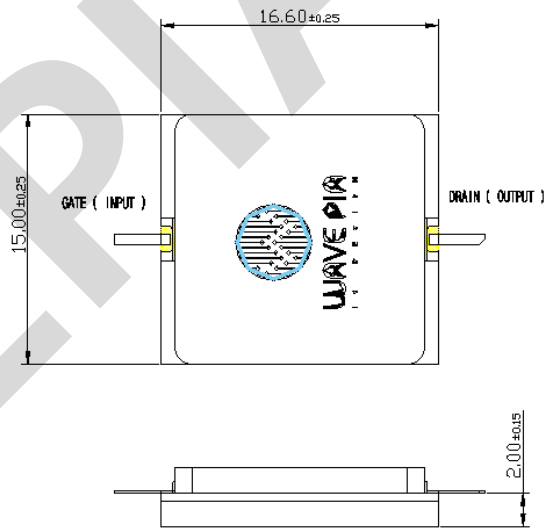
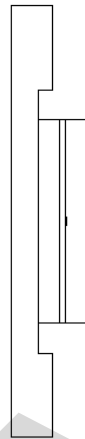
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Package Dimensions



Hole Mount type



Surface Mount type